

## EasyPACK™ module with CoolSiC™ Trench MOSFET and PressFIT / NTC / TIM

### Features

- Electrical features
  - $V_{DSS} = 1200\text{ V}$
  - $I_{DN} = 100\text{ A} / I_{DRM} = 200\text{ A}$
  - High current density
  - Low switching losses
- Mechanical features
  - Rugged mounting due to integrated mounting clamps
  - Integrated NTC temperature sensor
  - PressFIT contact technology
  - Pre-applied thermal interface material



Typical appearance

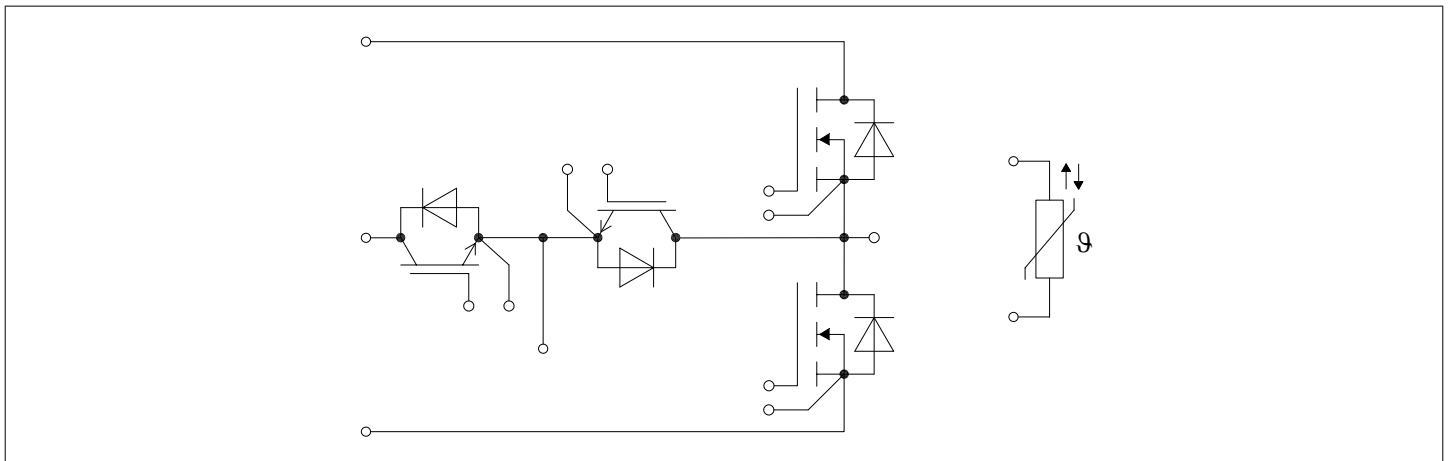
### Potential applications

- Solar applications
- Three-level applications
- DC charger for EV

### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

### Description



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## 1 Package

**Table 1 Insulation coordination**

| Parameter                           | Symbol      | Note or test condition                        | Values    | Unit |
|-------------------------------------|-------------|---|-----------|------|
| Isolation test voltage              | $V_{ISOL}$  | RMS, $f = 50 \text{ Hz}$ , $t = 60 \text{ s}$ | 3.0       | kV   |
| Internal isolation                  |             | basic insulation (class 1, IEC 61140)         | $Al_2O_3$ |      |
| Creepage distance                   | $d_{Creep}$ | terminal to heatsink                          | 11.5      | mm   |
| Creepage distance                   | $d_{Creep}$ | terminal to terminal                          | 6.3       | mm   |
| Clearance                           | $d_{Clear}$ | terminal to heatsink                          | 10.0      | mm   |
| Clearance                           | $d_{Clear}$ | terminal to terminal                          | 5.0       | mm   |
| Comparative tracking index          | $CTI$       |   | >200      |      |
| Relative thermal index (electrical) | $RTI$       | housing                                       | 140       | °C   |

**Table 2 Characteristic values**

| Parameter                                | Symbol        | Note or test condition                | Values |      |      | Unit |
|--|---------------|---------------------------------------|--------|------|------|------|
|  |               |                                       | Min.   | Typ. | Max. |      |
| Stray inductance module                  | $L_{SCE}$     |                                       |        | 12   |      | nH   |
| Module lead resistance, terminals - chip | $R_{CC'+EE'}$ | $T_H = 25^\circ\text{C}$ , per switch |        | 0.4  |      | mΩ   |
| Storage temperature                      | $T_{stg}$     |                                       | -40    |      | 125  | °C   |
| Maximum baseplate operation temperature  | $T_{BPmax}$   |                                       |        |      | 125  | °C   |
| Mounting force per clamp                 | $F$           |                                       | 40     |      | 80   | N    |
| Weight                                   | $G$           |                                       |        | 39   |      | g    |

Note: The current under continuous operation is limited to 25 A rms per connector pin.  
Storage and shipment of modules with TIM => see AN2012-07.

## 2 MOSFET

**Table 3 Maximum rated values**

| Parameter                     | Symbol    | Note or test condition  | Values | Unit |
|-------------------------------|-----------|---|--------|------|
| Drain-source voltage          | $V_{DSS}$ | $T_{vj} = 25^\circ\text{C}$   | 1200   | V    |
| Implemented drain current     | $I_{DN}$  |   | 100    | A    |
| Continuous DC drain current   | $I_{DDC}$ | $T_{vj} = 175^\circ\text{C}$ , $V_{GS} = 18 \text{ V}$ $T_H = 65^\circ\text{C}$ | 85     | A    |
| Repetitive peak drain current | $I_{DRM}$ | verified by design, $t_p$ limited by $T_{vjmax}$                                | 200    | A    |

(table continues...)

**Table 3 (continued) Maximum rated values**

| Parameter                                   | Symbol   | Note or test condition | Values | Unit |
|---|----------|------------------------|--------|------|
| Gate-source voltage, max. transient voltage | $V_{GS}$ | $D < 0.01$             | -10/23 | V    |
| Gate-source voltage, max. static voltage    | $V_{GS}$ |                        | -7/20  | V    |

**Table 4 Recommended values**

| Parameter              | Symbol        | Note or test condition | Values  | Unit |
|------------------------|---------------|------------------------|---------|------|
| On-state gate voltage  | $V_{GS(on)}$  |                        | 15...18 | V    |
| Off-state gate voltage | $V_{GS(off)}$ |                        | -5...0  | V    |

**Table 5 Characteristic values**

| Parameter                    | Symbol       | Note or test condition  | Values   |       |      | Unit |    |
|------------------------------|--------------|---|--|-------|------|------|----|
|                              |              |   | Min.   | Typ.  | Max. |      |    |
| Drain-source on-resistance   | $R_{DS(on)}$ | $I_D = 100\text{ A}$  | $V_{GS} = 18\text{ V}$ ,<br>$T_{vj} = 25\text{ °C}$  |       | 8.1  | 12   | mΩ |
|                              |              |   | $V_{GS} = 18\text{ V}$ ,<br>$T_{vj} = 125\text{ °C}$ |       | 13.1 |      |    |
|                              |              |   | $V_{GS} = 18\text{ V}$ ,<br>$T_{vj} = 175\text{ °C}$ |       | 17.4 |      |    |
|                              |              |   | $V_{GS} = 15\text{ V}$ ,<br>$T_{vj} = 25\text{ °C}$  |       | 9.7  |      |    |
| Gate threshold voltage       | $V_{GS(th)}$ | $I_D = 40\text{ mA}$ , $V_{DS} = V_{GS}$ , $T_{vj} = 25\text{ °C}$ , (tested after 1ms pulse at $V_{GS} = +20\text{ V}$ ) | 3.45   | 4.3   | 5.15 | V    |    |
| Total gate charge            | $Q_G$        | $V_{DS} = 800\text{ V}$ , $V_{GS} = -3/18\text{ V}$   |  | 0.297 |      | μC   |    |
| Internal gate resistor       | $R_{Gint}$   | $T_{vj} = 25\text{ °C}$   |  | 2.1   |      | Ω    |    |
| Input capacitance            | $C_{ISS}$    | $f = 100\text{ kHz}$ , $V_{DS} = 800\text{ V}$ ,<br>$V_{GS} = 0\text{ V}$   |  | 8.8   |      | nF   |    |
| Output capacitance           | $C_{OSS}$    | $f = 100\text{ kHz}$ , $V_{DS} = 800\text{ V}$ ,<br>$V_{GS} = 0\text{ V}$   |  | 0.42  |      | nF   |    |
| Reverse transfer capacitance | $C_{rSS}$    | $f = 100\text{ kHz}$ , $V_{DS} = 800\text{ V}$ ,<br>$V_{GS} = 0\text{ V}$   |  | 0.028 |      | nF   |    |
| $C_{OSS}$ stored energy      | $E_{OSS}$    | $V_{DS} = 800\text{ V}$ , $V_{GS} = -3/18\text{ V}$ , $T_{vj} = 25\text{ °C}$   |  | 172   |      | μJ   |    |
| Drain-source leakage current | $I_{DSS}$    | $V_{DS} = 1200\text{ V}$ , $V_{GS} = -3\text{ V}$   |  | 0.06  | 380  | μA   |    |
| Gate-source leakage current  | $I_{GSS}$    | $V_{DS} = 0\text{ V}$ , $T_{vj} = 25\text{ °C}$   | $V_{GS} = 20\text{ V}$                               |       | 400  | nA   |    |

**(table continues...)**

**Table 5** (continued) **Characteristic values**

| Parameter                                 | Symbol       | Note or test condition   | Values                   |      |       | Unit       |
|---|--------------|--|--------------------------|------|-------|------------|
|   |              |  | Min.                     | Typ. | Max.  |            |
| Turn-on delay time (inductive load)       | $t_{d\ on}$  | $I_D = 100\ A, R_{Gon} = 15\ \Omega, V_{DS} = 400\ V, V_{GS} = -3/18\ V$   | $T_{vj} = 25\ ^\circ C$  | 83   |       | ns         |
|   |              |  | $T_{vj} = 125\ ^\circ C$ | 73   |       |            |
|   |              |  | $T_{vj} = 175\ ^\circ C$ | 70   |       |            |
| Rise time (inductive load)                | $t_r$        | $I_D = 100\ A, R_{Gon} = 15\ \Omega, V_{DS} = 400\ V, V_{GS} = -3/18\ V$   | $T_{vj} = 25\ ^\circ C$  | 106  |       | ns         |
|   |              |  | $T_{vj} = 125\ ^\circ C$ | 111  |       |            |
|   |              |  | $T_{vj} = 175\ ^\circ C$ | 116  |       |            |
| Turn-off delay time (inductive load)      | $t_{d\ off}$ | $I_D = 100\ A, R_{Goff} = 3.3\ \Omega, V_{DS} = 400\ V, V_{GS} = -3/18\ V$   | $T_{vj} = 25\ ^\circ C$  | 74   |       | ns         |
|   |              |  | $T_{vj} = 125\ ^\circ C$ | 80   |       |            |
|   |              |  | $T_{vj} = 175\ ^\circ C$ | 84   |       |            |
| Fall time (inductive load)                | $t_f$        | $I_D = 100\ A, R_{Goff} = 3.3\ \Omega, V_{DS} = 400\ V, V_{GS} = -3/18\ V$   | $T_{vj} = 25\ ^\circ C$  | 17   |       | ns         |
|   |              |  | $T_{vj} = 125\ ^\circ C$ | 16   |       |            |
|   |              |  | $T_{vj} = 175\ ^\circ C$ | 16   |       |            |
| Turn-on energy loss per pulse             | $E_{on}$     | $I_D = 100\ A, V_{DS} = 400\ V, L_\sigma = 27\ nH, V_{GS} = -3/18\ V, R_{Gon} = 15\ \Omega, di/dt = 2\ kA/\mu s (T_{vj} = 175\ ^\circ C)$      | $T_{vj} = 25\ ^\circ C$  | 3.28 |       | mJ         |
|   |              |  | $T_{vj} = 125\ ^\circ C$ | 3.97 |       |            |
|   |              |  | $T_{vj} = 175\ ^\circ C$ | 4.33 |       |            |
| Turn-off energy loss per pulse            | $E_{off}$    | $I_D = 100\ A, V_{DS} = 400\ V, L_\sigma = 27\ nH, V_{GS} = -3/18\ V, R_{Goff} = 3.3\ \Omega, dv/dt = 20.1\ kV/\mu s (T_{vj} = 175\ ^\circ C)$ | $T_{vj} = 25\ ^\circ C$  | 0.32 |       | mJ         |
|   |              |  | $T_{vj} = 125\ ^\circ C$ | 0.38 |       |            |
|   |              |  | $T_{vj} = 175\ ^\circ C$ | 0.42 |       |            |
| Thermal resistance, junction to heat sink | $R_{thJH}$   | per MOSFET, Valid with IFX pre-applied Thermal Interface Material  |                          |      | 0.581 | K/W        |
| Temperature under switching conditions    | $T_{vj\ op}$ |  | -40                      |      | 175   | $^\circ C$ |

*Note: The selection of positive and negative gate-source voltages impacts the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Note AN 2018-09 must be considered to ensure sound operation of the device over the planned lifetime.*

*Tvj op > 150°C is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.*

### 3 Body diode

**Table 6** **Maximum rated values**

| Parameter                     | Symbol   | Note or test condition                                       | Values | Unit |
|-------------------------------|----------|--|--------|------|
| DC body diode forward current | $I_{SD}$ | $T_{vj} = 175\ ^\circ C, V_{GS} = -3\ V, T_H = 65\ ^\circ C$ | 32     | A    |

**Table 7 Characteristic values**

| Parameter       | Symbol   | Note or test condition                          | Values                                |      |      | Unit |   |
|-----------------|----------|---|---------------------------------------|------|------|------|---|
|                 |          |   | Min.                                  | Typ. | Max. |      |   |
| Forward voltage | $V_{SD}$ | $I_{SD} = 100 \text{ A}, V_{GS} = -3 \text{ V}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  |      | 4.2  | 5.35 | V |
|                 |          |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 3.9  |      |   |
|                 |          |   | $T_{vj} = 175 \text{ }^\circ\text{C}$ |      | 3.8  |      |   |

## 4 IGBT, 3-Level

**Table 8 Maximum rated values**

| Parameter                         | Symbol    | Note or test condition   | Values   | Unit |
|-----------------------------------|-----------|--|----------|------|
| Collector-emitter voltage         | $V_{CES}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$   | 650      | V    |
| Implemented collector current     | $I_{CN}$  |  | 200      | A    |
| Continuous DC collector current   | $I_{CDC}$ | $T_{vj \text{ max}} = 175 \text{ }^\circ\text{C}$<br>$T_H = 65 \text{ }^\circ\text{C}$ | 90       | A    |
| Repetitive peak collector current | $I_{CRM}$ | $t_p$ limited by $T_{vj \text{ op}}$   | 200      | A    |
| Gate-emitter peak voltage         | $V_{GES}$ |  | $\pm 20$ | V    |

**Table 9 Characteristic values**

| Parameter                            | Symbol               | Note or test condition  | Values                                |      |       | Unit          |               |
|--------------------------------------|----------------------|---|---------------------------------------|------|-------|---------------|---------------|
|                                      |                      |   | Min.                                  | Typ. | Max.  |               |               |
| Collector-emitter saturation voltage | $V_{CE \text{ sat}}$ | $I_C = 100 \text{ A}, V_{GE} = 15 \text{ V}$  | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 0.74 | 1.17  | 1.59          | V             |
|                                      |                      |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 1.20  |               |               |
|                                      |                      |   | $T_{vj} = 150 \text{ }^\circ\text{C}$ |      | 1.21  |               |               |
| Gate threshold voltage               | $V_{Geth}$           | $I_C = 2 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25 \text{ }^\circ\text{C}$                               | 3.25                                  | 4    | 4.75  | V             |               |
| Gate charge                          | $Q_G$                | $V_{GE} = \pm 15 \text{ V}, V_{CE} = 400 \text{ V}$   |                                       | 0.84 |       | $\mu\text{C}$ |               |
| Internal gate resistor               | $R_{Gint}$           | $T_{vj} = 25 \text{ }^\circ\text{C}$  |                                       | 0    |       | $\Omega$      |               |
| Input capacitance                    | $C_{ies}$            | $f = 100 \text{ kHz}, T_{vj} = 25 \text{ }^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$  |                                       | 14.3 |       | nF            |               |
| Reverse transfer capacitance         | $C_{res}$            | $f = 100 \text{ kHz}, T_{vj} = 25 \text{ }^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$  |                                       | 0.05 |       | nF            |               |
| Collector-emitter cut-off current    | $I_{CES}$            | $V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$<br>$T_{vj} = 25 \text{ }^\circ\text{C}$                  |                                       |      | 1     | mA            |               |
| Gate-emitter leakage current         | $I_{GES}$            | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$                       |                                       |      | 100   | nA            |               |
| Turn-on delay time (inductive load)  | $t_{don}$            | $I_C = 100 \text{ A}, V_{CE} = 400 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 2.7 \text{ } \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  |      | 0.014 |               | $\mu\text{s}$ |
|                                      |                      |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 0.015 |               |               |
|                                      |                      |   | $T_{vj} = 150 \text{ }^\circ\text{C}$ |      | 0.015 |               |               |

(table continues...)

**Table 9** (continued) **Characteristic values**

| Parameter                                 | Symbol      | Note or test condition   | Values                                |       |       | Unit             |
|---|-------------|--|---------------------------------------|-------|-------|------------------|
|   |             |  | Min.                                  | Typ.  | Max.  |                  |
| Rise time (inductive load)                | $t_r$       | $I_C = 100 \text{ A}, V_{CE} = 400 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 2.7 \Omega$   | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 0.009 |       | $\mu\text{s}$    |
|   |             |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ | 0.010 |       |                  |
|   |             |  | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 0.011 |       |                  |
| Turn-off delay time (inductive load)      | $t_{doff}$  | $I_C = 100 \text{ A}, V_{CE} = 400 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 39 \Omega$   | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 0.650 |       | $\mu\text{s}$    |
|   |             |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ | 0.680 |       |                  |
|   |             |  | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 0.700 |       |                  |
| Fall time (inductive load)                | $t_f$       | $I_C = 100 \text{ A}, V_{CE} = 400 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 39 \Omega$   | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 0.023 |       | $\mu\text{s}$    |
|   |             |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ | 0.045 |       |                  |
|   |             |  | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 0.055 |       |                  |
| Turn-on energy loss per pulse             | $E_{on}$    | $I_C = 100 \text{ A}, V_{CE} = 400 \text{ V}, L_\sigma = 27 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 2.7 \Omega, di/dt = 7600 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 0.264 |       | mJ               |
|   |             |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ | 0.394 |       |                  |
|   |             |  | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 0.438 |       |                  |
| Turn-off energy loss per pulse            | $E_{off}$   | $I_C = 100 \text{ A}, V_{CE} = 400 \text{ V}, L_\sigma = 27 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 39 \Omega, dv/dt = 4800 \text{ V}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 1.7   |       | mJ               |
|   |             |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ | 2.05  |       |                  |
|   |             |  | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 2.31  |       |                  |
| Thermal resistance, junction to heat sink | $R_{thJH}$  | per IGBT, Valid with IFX pre-applied Thermal Interface Material  |                                       |       | 0.723 | K/W              |
| Temperature under switching conditions    | $T_{vj op}$ |  | -40                                   |       | 150   | $^\circ\text{C}$ |

## 5 Diode, 3-Level

**Table 10** **Maximum rated values**

| Parameter                       | Symbol    | Note or test condition                   | Values                                | Unit |                      |
|---------------------------------|-----------|--|---------------------------------------|------|----------------------|
| Repetitive peak reverse voltage | $V_{RRM}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$     | 650                                   | V    |                      |
| Implemented forward current     | $I_{FN}$  |  | 150                                   | A    |                      |
| Continuous DC forward current   | $I_F$     |  | 100                                   | A    |                      |
| Repetitive peak forward current | $I_{FRM}$ | $t_P = 1 \text{ ms}$                     | 200                                   | A    |                      |
| $I^2t$ - value                  | $I^2t$    | $V_R = 0 \text{ V}, t_P = 10 \text{ ms}$ | $T_{vj} = 125 \text{ }^\circ\text{C}$ | 1270 | $\text{A}^2\text{s}$ |
|                                 |           |  | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 1480 |                      |

**Table 11** Characteristic values

| Parameter                                 | Symbol      | Note or test condition  | Values                                |      |       | Unit             |               |
|---|-------------|---|---------------------------------------|------|-------|------------------|---------------|
|   |             |   | Min.                                  | Typ. | Max.  |                  |               |
| Forward voltage                           | $V_F$       | $I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$   | $T_{vj} = 25 \text{ }^\circ\text{C}$  | 0.74 | 1.35  | 1.86             | V             |
|   |             |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 1.29  |                  |               |
|   |             |   | $T_{vj} = 150 \text{ }^\circ\text{C}$ |      | 1.25  |                  |               |
| Peak reverse recovery current             | $I_{RM}$    | $I_F = 100 \text{ A}, V_R = 400 \text{ V}, V_{GE} = -15 \text{ V}, -di_F/dt = 2000 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  |      | 64.2  |                  | A             |
|   |             |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 99.8  |                  |               |
|   |             |   | $T_{vj} = 150 \text{ }^\circ\text{C}$ |      | 114   |                  |               |
| Recovered charge                          | $Q_r$       | $I_F = 100 \text{ A}, V_R = 400 \text{ V}, V_{GE} = -15 \text{ V}, -di_F/dt = 2000 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  |      | 3.99  |                  | $\mu\text{C}$ |
|   |             |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 7.07  |                  |               |
|   |             |   | $T_{vj} = 150 \text{ }^\circ\text{C}$ |      | 9.8   |                  |               |
| Reverse recovery energy                   | $E_{rec}$   | $I_F = 100 \text{ A}, V_R = 400 \text{ V}, V_{GE} = -15 \text{ V}, -di_F/dt = 2000 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$ | $T_{vj} = 25 \text{ }^\circ\text{C}$  |      | 0.45  |                  | mJ            |
|   |             |   | $T_{vj} = 125 \text{ }^\circ\text{C}$ |      | 1     |                  |               |
|   |             |   | $T_{vj} = 150 \text{ }^\circ\text{C}$ |      | 1.35  |                  |               |
| Thermal resistance, junction to heat sink | $R_{thJH}$  | per diode, Valid with IFX pre-applied Thermal Interface Material  |                                       |      | 0.802 | K/W              |               |
| Temperature under switching conditions    | $T_{vj op}$ |   | -40                                   |      | 150   | $^\circ\text{C}$ |               |

## 6 NTC-Thermistor

**Table 12** Characteristic values

| Parameter              | Symbol       | Note or test condition  | Values |      |      | Unit       |
|------------------------|--------------|---|--------|------|------|------------|
|                        |              |   | Min.   | Typ. | Max. |            |
| Rated resistance       | $R_{25}$     | $T_{NTC} = 25 \text{ }^\circ\text{C}$                                 |        | 5    |      | k $\Omega$ |
| Deviation of $R_{100}$ | $\Delta R/R$ | $T_{NTC} = 100 \text{ }^\circ\text{C}, R_{100} = 493 \text{ } \Omega$ | -5     |      | 5    | %          |
| Power dissipation      | $P_{25}$     | $T_{NTC} = 25 \text{ }^\circ\text{C}$                                 |        |      | 20   | mW         |
| B-value                | $B_{25/50}$  | $R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$          |        | 3375 |      | K          |
| B-value                | $B_{25/80}$  | $R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$          |        | 3411 |      | K          |
| B-value                | $B_{25/100}$ | $R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$         |        | 3433 |      | K          |

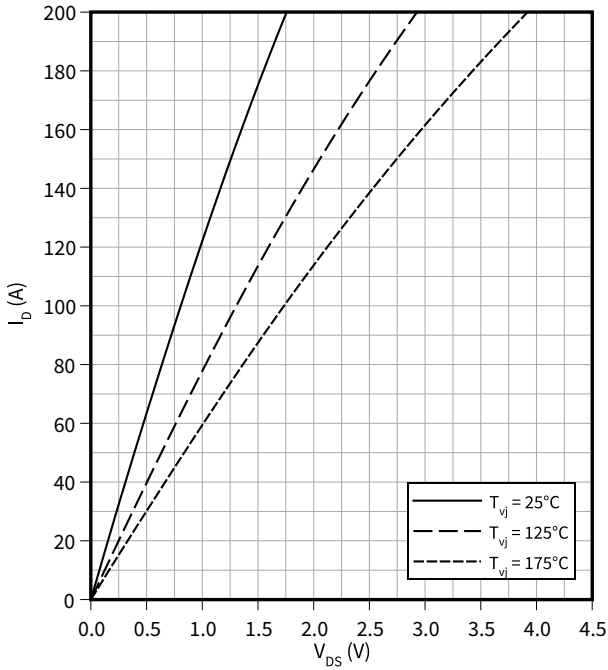
Note: Specification according to the valid application note.



## 7 Characteristics diagrams

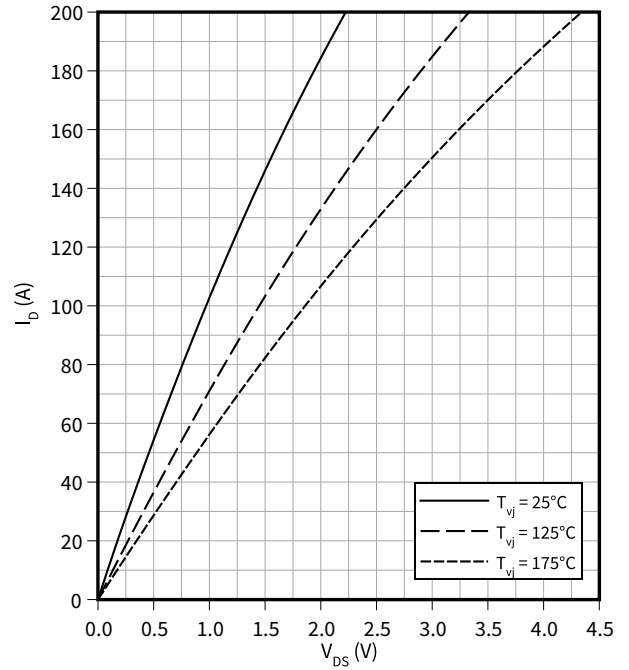
**output characteristic (typical), MOSFET**

$I_D = f(V_{DS})$   
 $V_{GS} = 18\text{ V}$



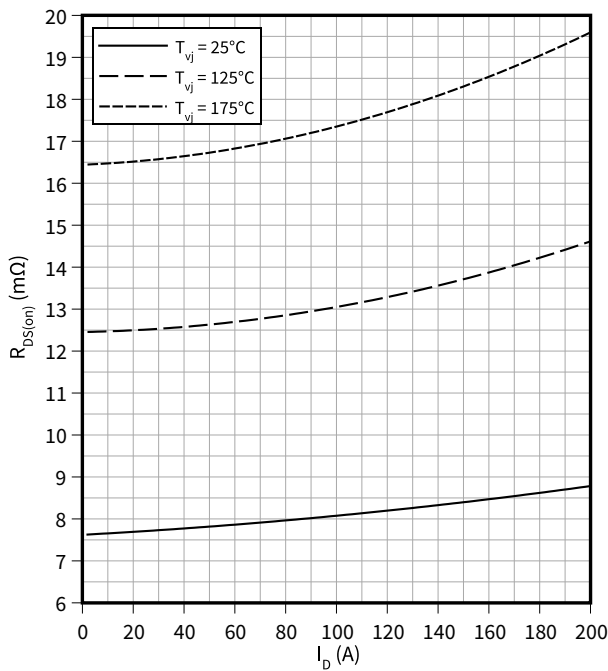
**output characteristic (typical), MOSFET**

$I_D = f(V_{DS})$   
 $V_{GS} = 15\text{ V}$



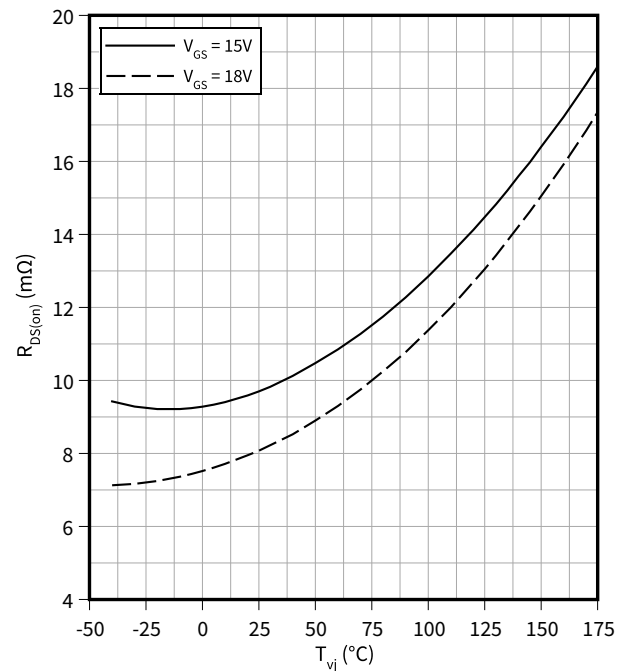
**Drain source on-resistance (typical), MOSFET**

$R_{DS(on)} = f(I_D)$   
 $V_{GS} = 18\text{ V}$



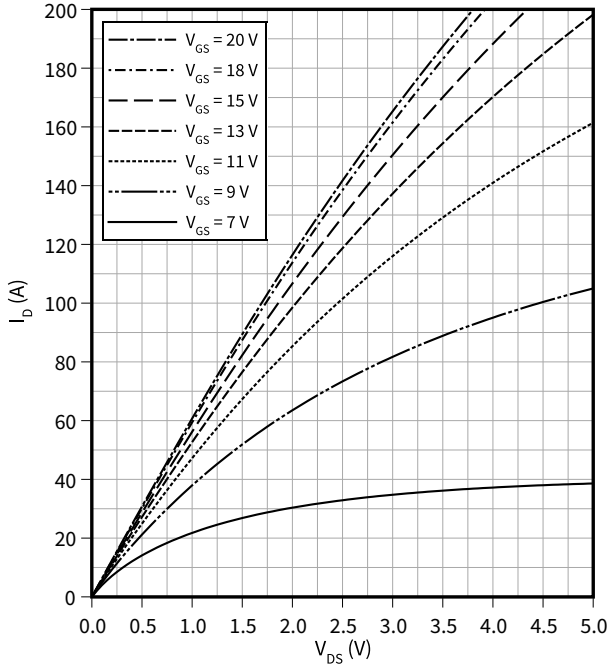
**Drain source on-resistance (typical), MOSFET**

$R_{DS(on)} = f(T_{vj})$   
 $I_D = 100\text{ A}$



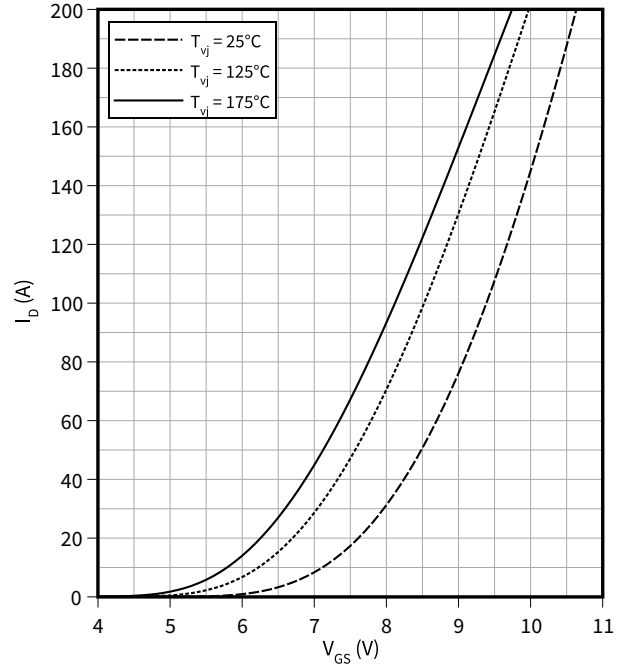
**Output characteristic field (typical), MOSFET**

$I_D = f(V_{DS})$   
 $T_{vj} = 175\text{ °C}$



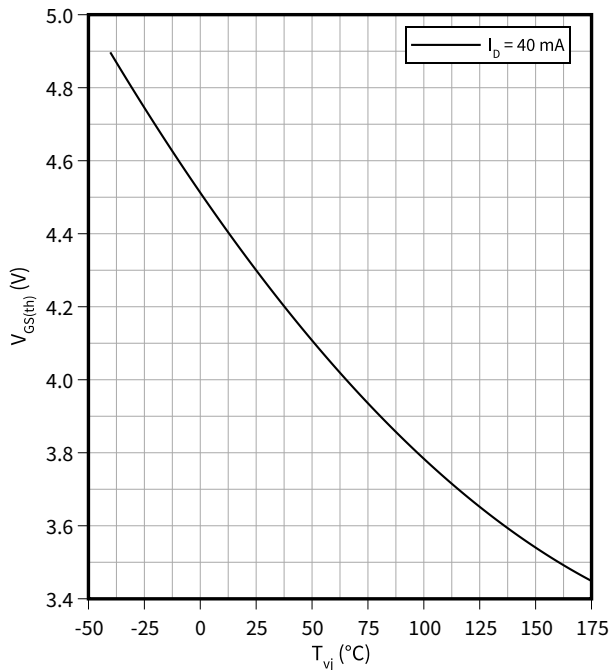
**Transfer characteristic (typical), MOSFET**

$I_D = f(V_{GS})$   
 $V_{DS} = 20\text{ V}$



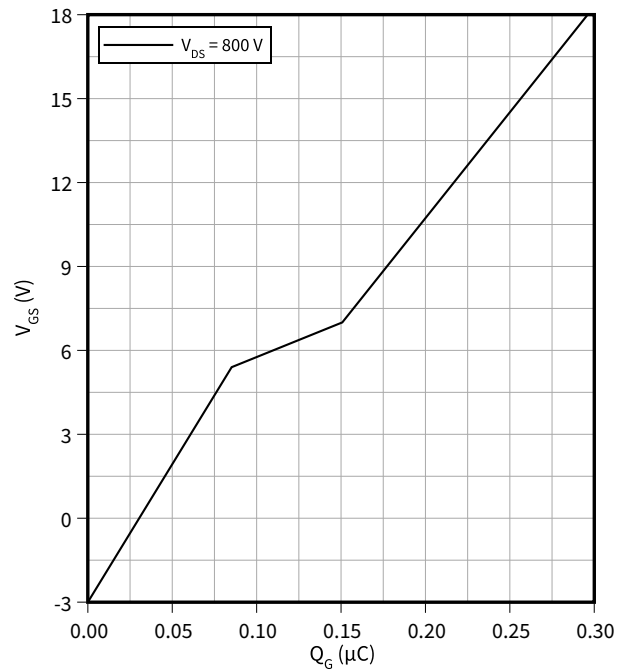
**Gate-source threshold voltage (typical), MOSFET**

$V_{GS(th)} = f(T_{vj})$   
 $V_{GS} = V_{DS}$



**Gate charge characteristic (typical), MOSFET**

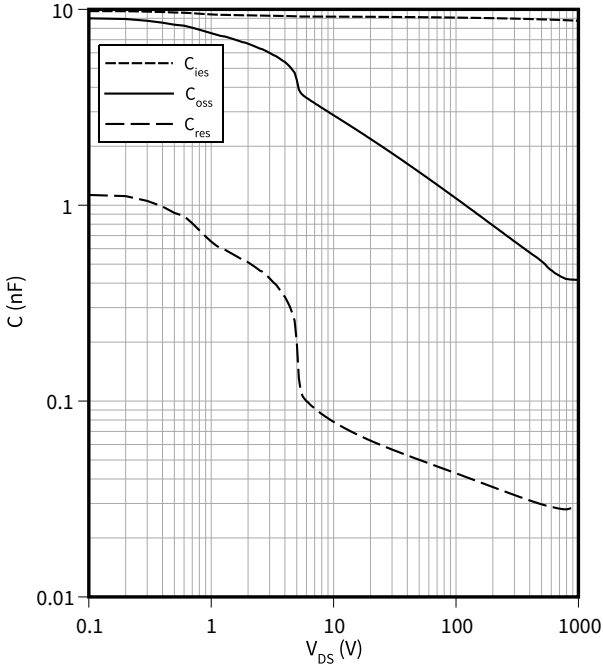
$V_{GS} = f(Q_G)$   
 $I_D = 100\text{ A}, T_{vj} = 25\text{ °C}$



7 Characteristics diagrams

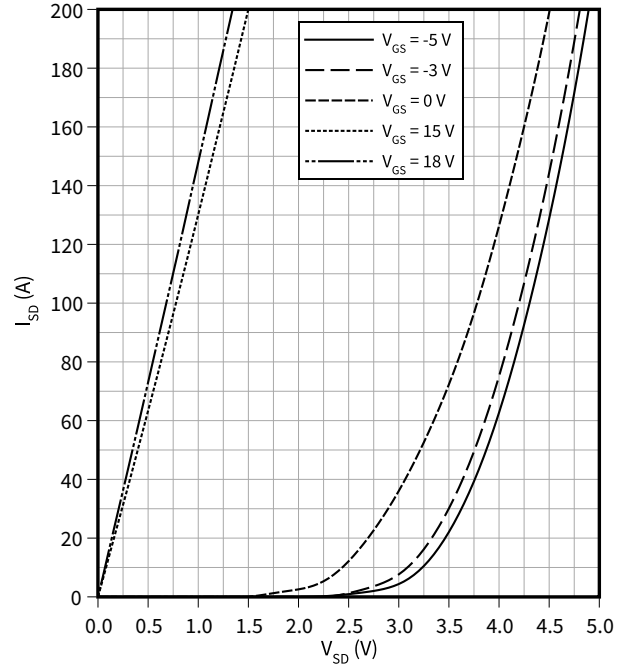
**Capacity characteristic (typical), MOSFET**

$C = f(V_{DS})$   
 $f = 100 \text{ kHz}, T_{vj} = 25 \text{ °C}, V_{GS} = 0 \text{ V}$



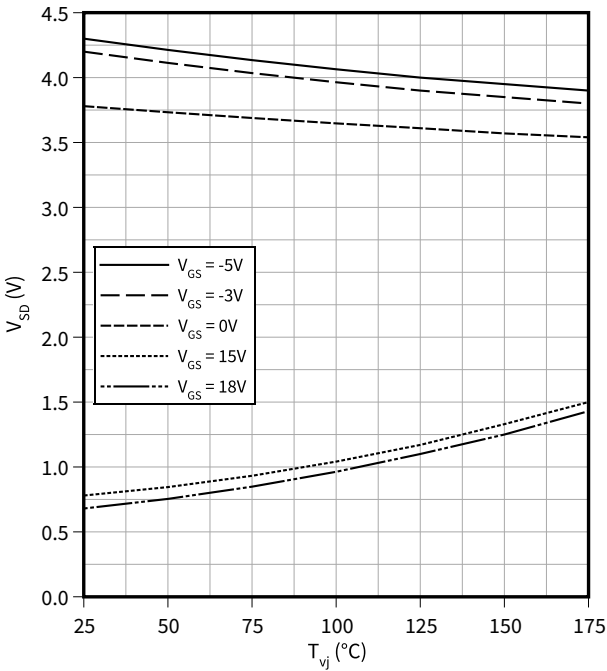
**Forward characteristic body diode (typical), MOSFET**

$I_{SD} = f(V_{SD})$   
 $T_{vj} = 25 \text{ °C}$



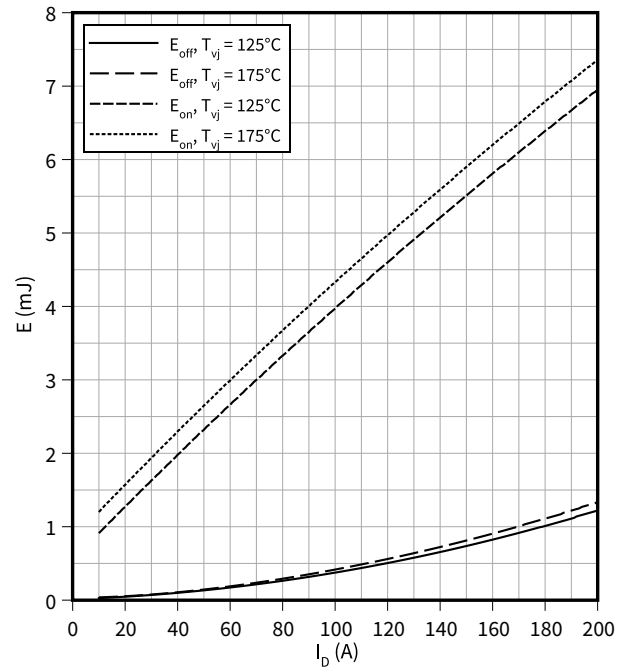
**Forward voltage of body diode (typical), MOSFET**

$V_{SD} = f(T_{vj})$   
 $I_{SD} = 100 \text{ A}$



**Switching losses (typical), MOSFET**

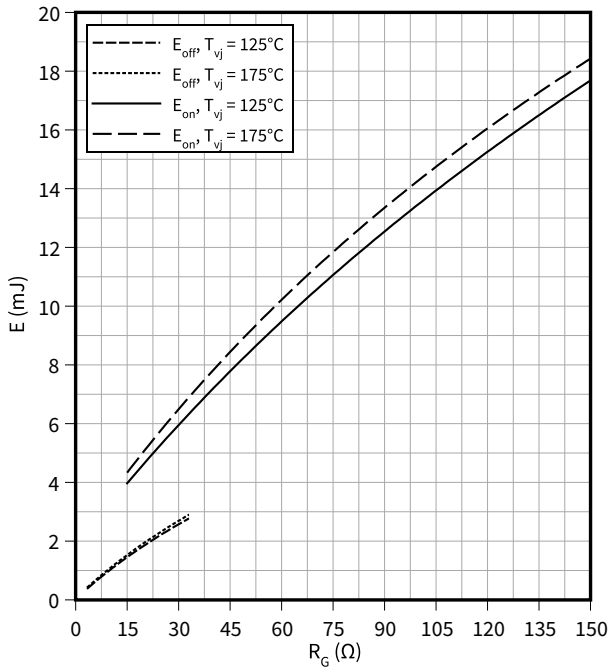
$E = f(I_D)$   
 $R_{Goff} = 3.3 \text{ } \Omega, R_{Gon} = 15 \text{ } \Omega, V_{DS} = 400 \text{ V}, V_{GS} = -3/18 \text{ V}$



**Switching losses (typical), MOSFET**

$E = f(R_G)$

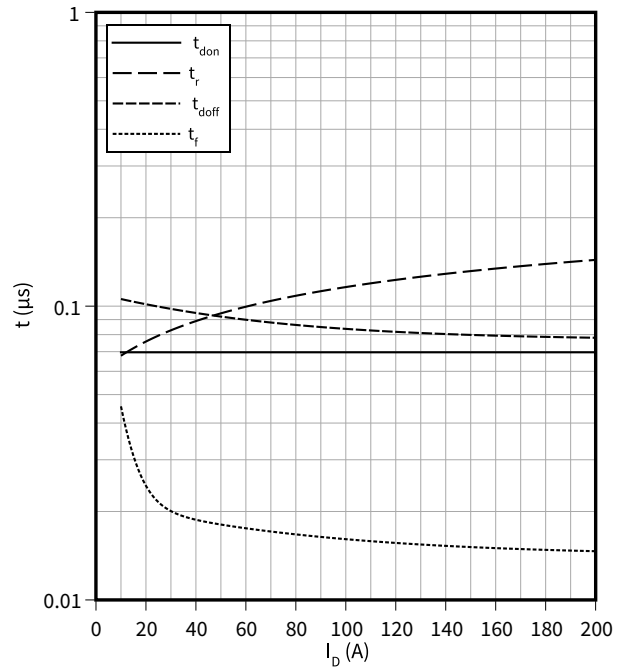
$V_{DS} = 400\text{ V}$ ,  $I_D = 100\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



**Switching times (typical), MOSFET**

$t = f(I_D)$

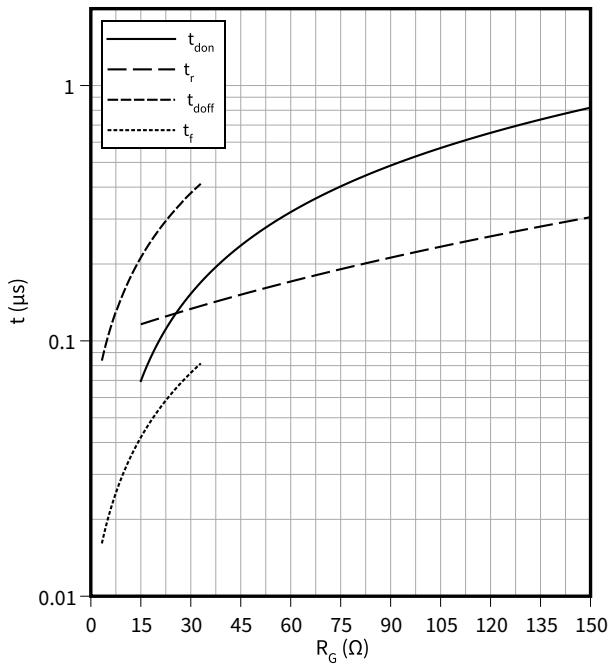
$R_{Goff} = 3.3\ \Omega$ ,  $R_{Gon} = 15\ \Omega$ ,  $V_{DS} = 400\text{ V}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GS} = -3/18\text{ V}$



**Switching times (typical), MOSFET**

$t = f(R_G)$

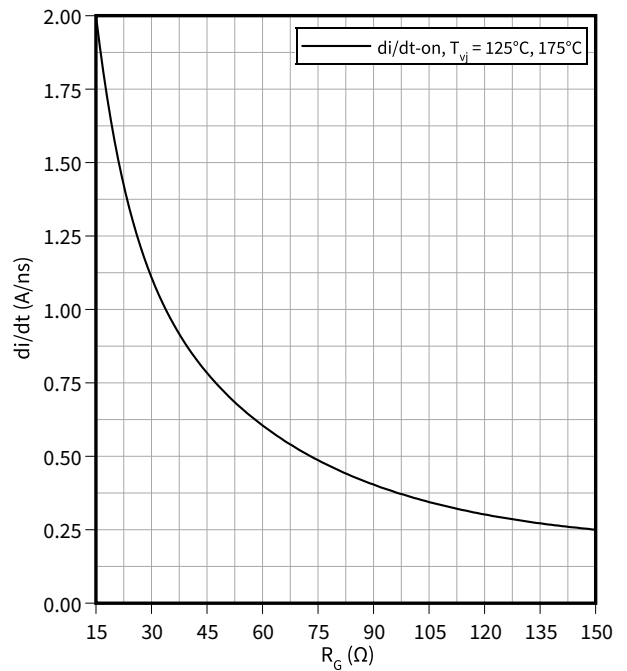
$V_{DS} = 400\text{ V}$ ,  $I_D = 100\text{ A}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GS} = -3/18\text{ V}$



**Current slope (typical), MOSFET**

$di/dt = f(R_G)$

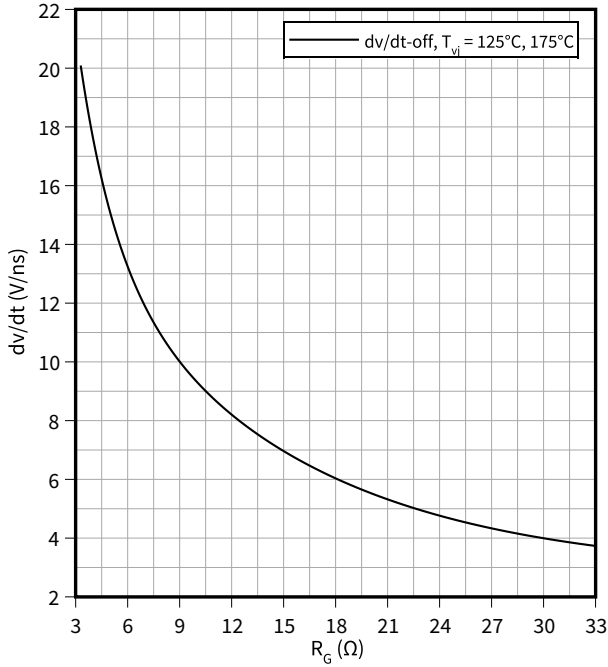
$V_{DS} = 400\text{ V}$ ,  $I_D = 100\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



**Voltage slope (typical), MOSFET**

$dv/dt = f(R_G)$

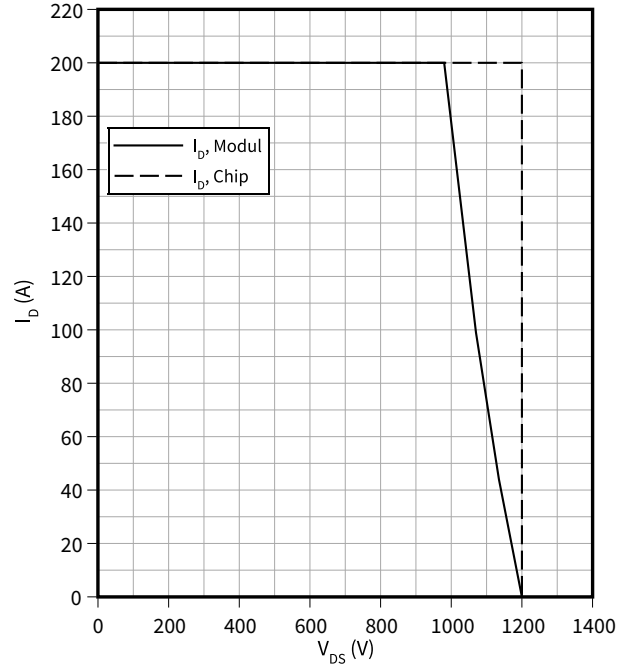
$V_{DS} = 400\text{ V}$ ,  $I_D = 100\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



**Reverse bias safe operating area (RBSOA), MOSFET**

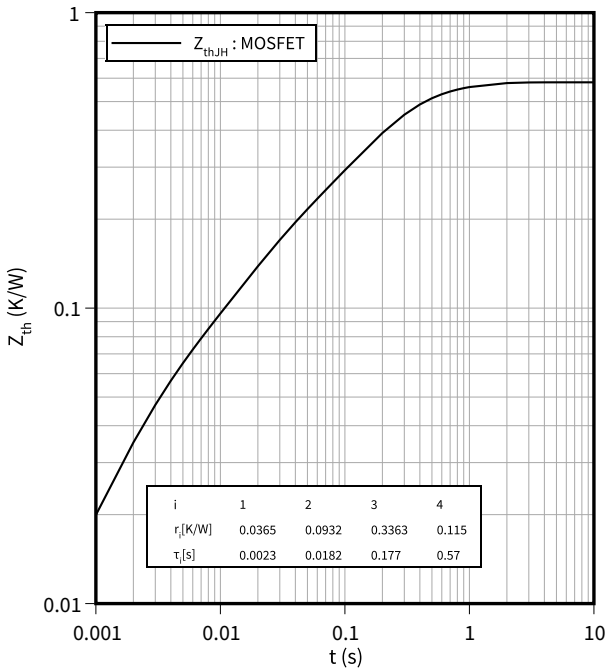
$I_D = f(V_{DS})$

$R_{Goff} = 3.3\ \Omega$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GS} = -3/18\text{ V}$



**Transient thermal impedance, MOSFET**

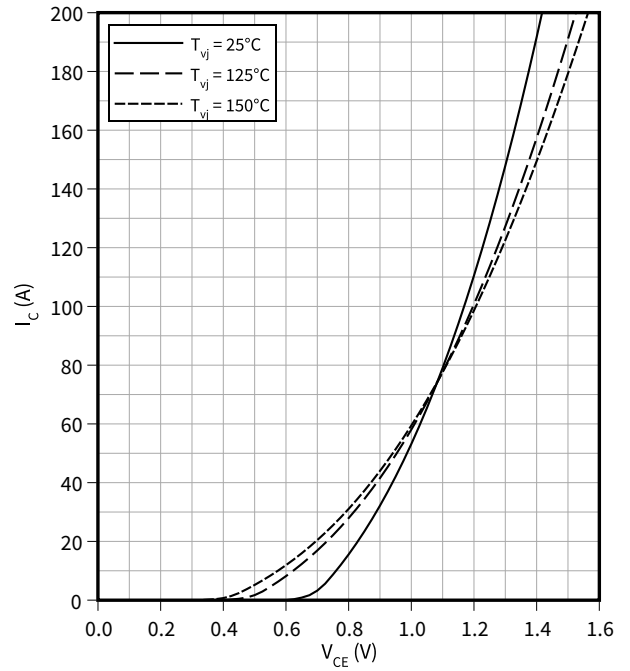
$Z_{th} = f(t)$



**Output characteristic (typical), IGBT, 3-Level**

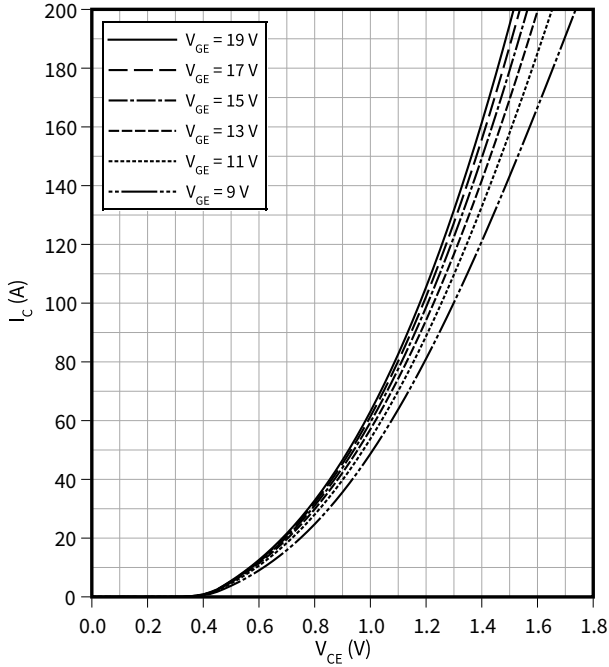
$I_C = f(V_{CE})$

$V_{GE} = 15\text{ V}$



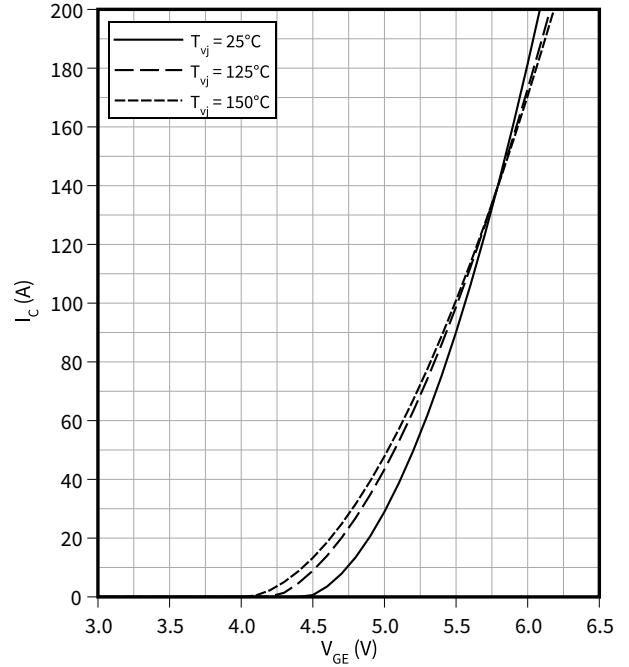
**Output characteristic field (typical), IGBT, 3-Level**

$I_C = f(V_{CE})$   
 $T_{vj} = 150\text{ °C}$



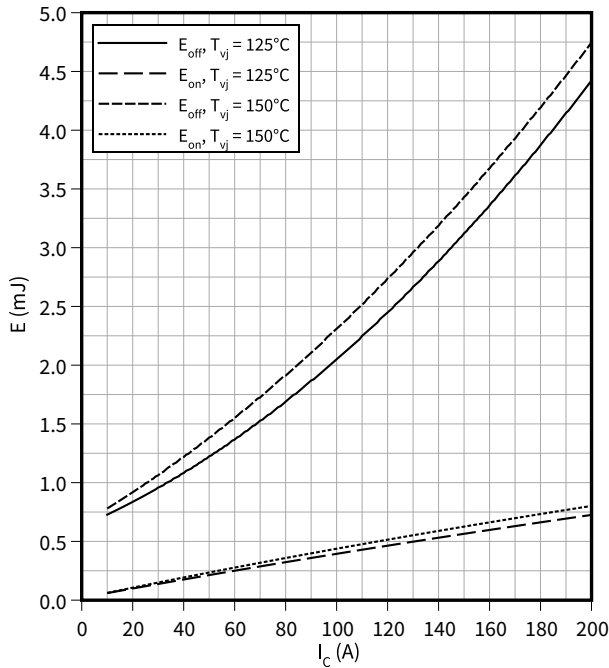
**Transfer characteristic (typical), IGBT, 3-Level**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



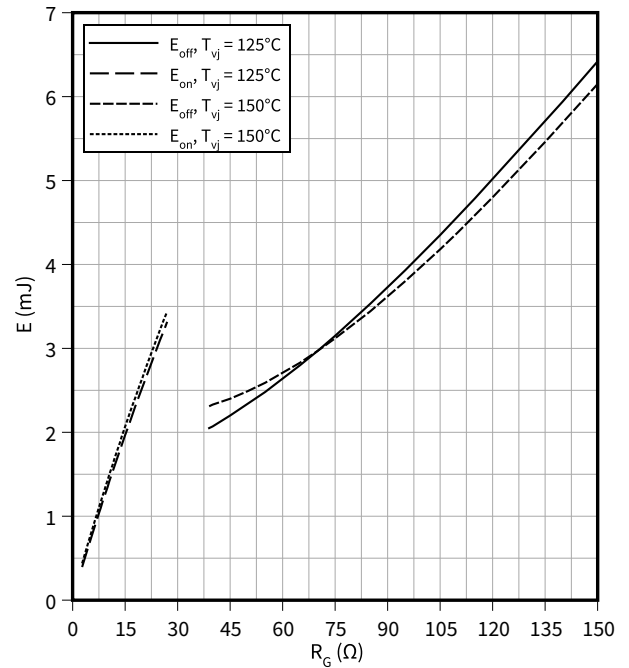
**Switching losses (typical), IGBT, 3-Level**

$E = f(I_C)$   
 $R_{Goff} = 39\ \Omega$ ,  $R_{Gon} = 2.7\ \Omega$ ,  $V_{CE} = 400\text{ V}$ ,  $V_{GE} = -15 / +15\text{ V}$



**Switching losses (typical), IGBT, 3-Level**

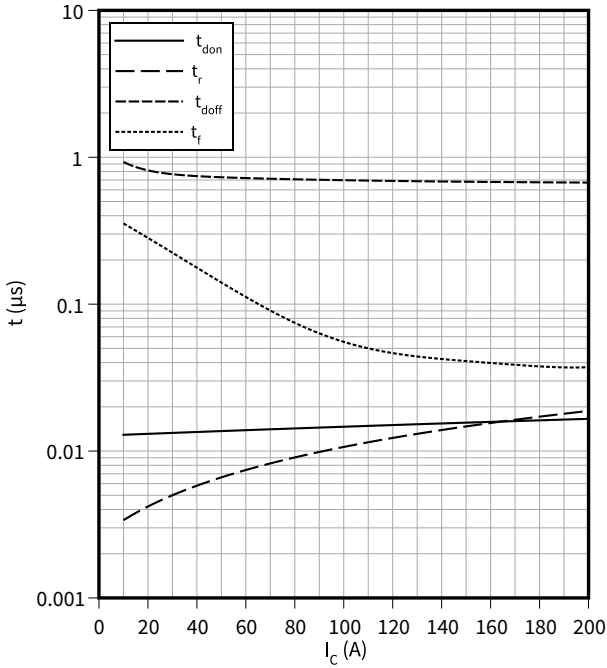
$E = f(R_G)$   
 $I_C = 100\text{ A}$ ,  $V_{CE} = 400\text{ V}$ ,  $V_{GE} = -15 / +15\text{ V}$



**Switching times (typical), IGBT, 3-Level**

$t = f(I_C)$

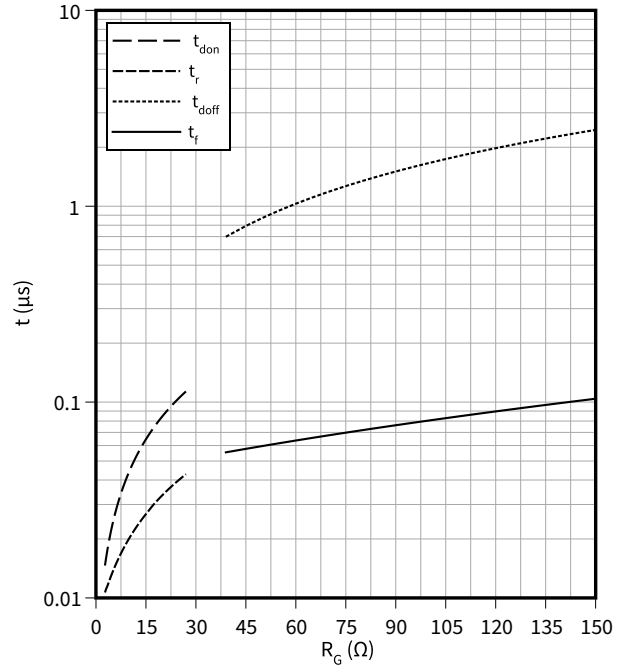
$R_{Goff} = 39 \Omega$ ,  $R_{Gon} = 2.7 \Omega$ ,  $R_{Gon} = 2.7 \Omega$ ,  $V_{CE} = 400 V$ ,  $V_{GE} = \pm 15 V$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Switching times (typical), IGBT, 3-Level**

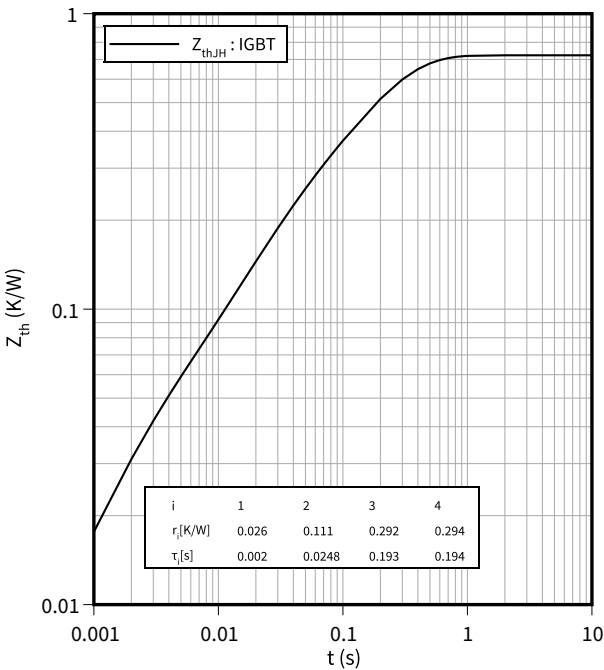
$t = f(R_G)$

$I_C = 100 A$ ,  $V_{CE} = 400 V$ ,  $V_{GE} = -15 / +15 V$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Transient thermal impedance, IGBT, 3-Level**

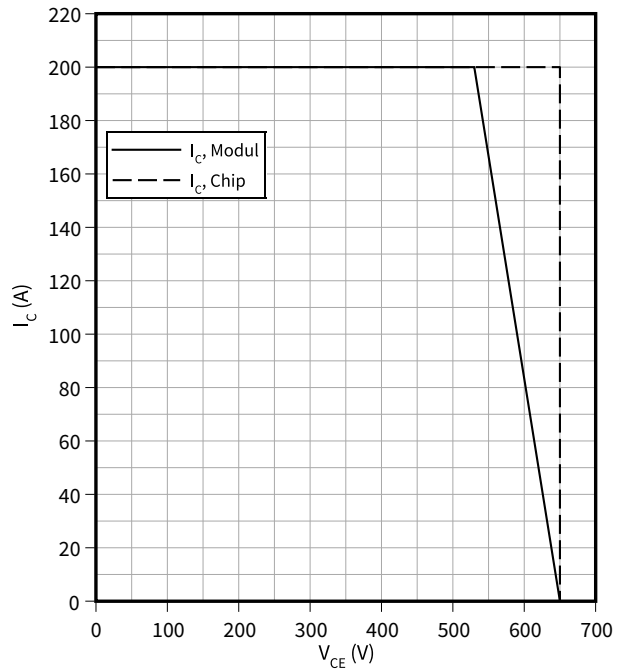
$Z_{th} = f(t)$



**Reverse bias safe operating area (RBSOA), IGBT, 3-Level**

$I_C = f(V_{CE})$

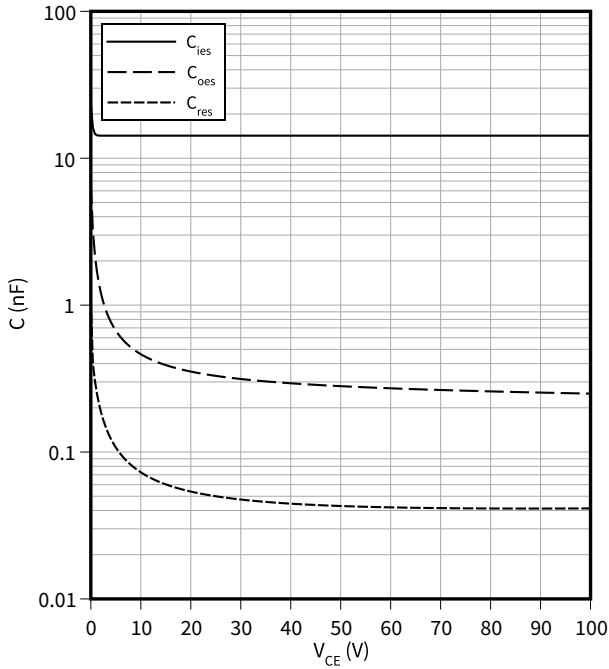
$T_{vj} = 150 \text{ }^\circ\text{C}$ ,  $R_{Goff} = 39 \Omega$ ,  $V_{GE} = \pm 15 V$



7 Characteristics diagrams

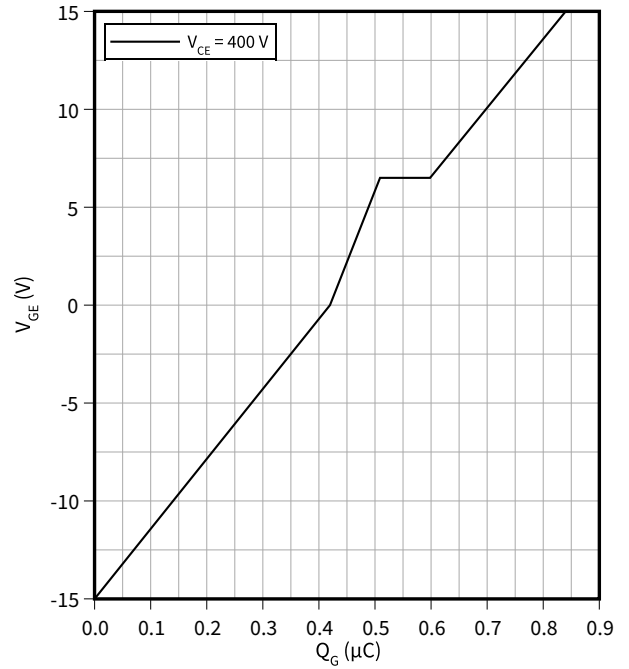
**Capacity characteristic (typical), IGBT, 3-Level**

$C = f(V_{CE})$   
 $f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$



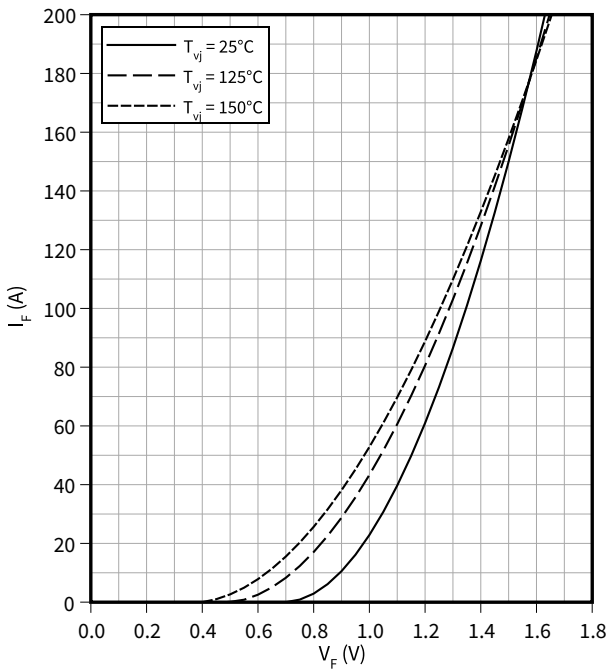
**Gate charge characteristic (typical), IGBT, 3-Level**

$V_{GE} = f(Q_G)$   
 $I_C = 100 \text{ A}, T_{vj} = 25 \text{ }^\circ\text{C}$



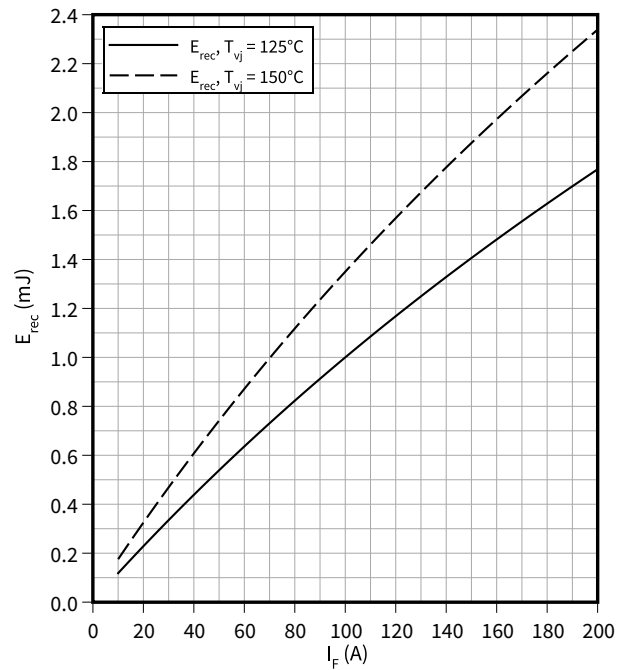
**Forward characteristic (typical), Diode, 3-Level**

$I_F = f(V_F)$



**Switching losses (typical), Diode, 3-Level**

$E_{rec} = f(I_F)$   
 $R_G = 15 \text{ } \Omega, V_R = 400 \text{ V}$

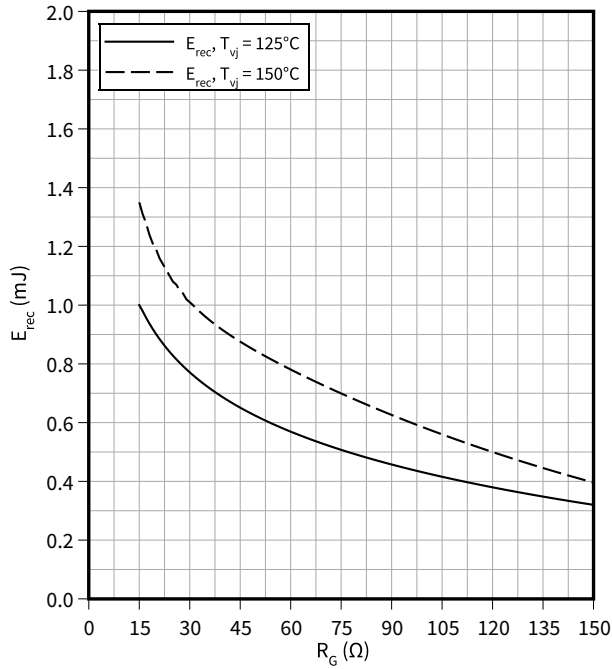




**Switching losses (typical), Diode, 3-Level**

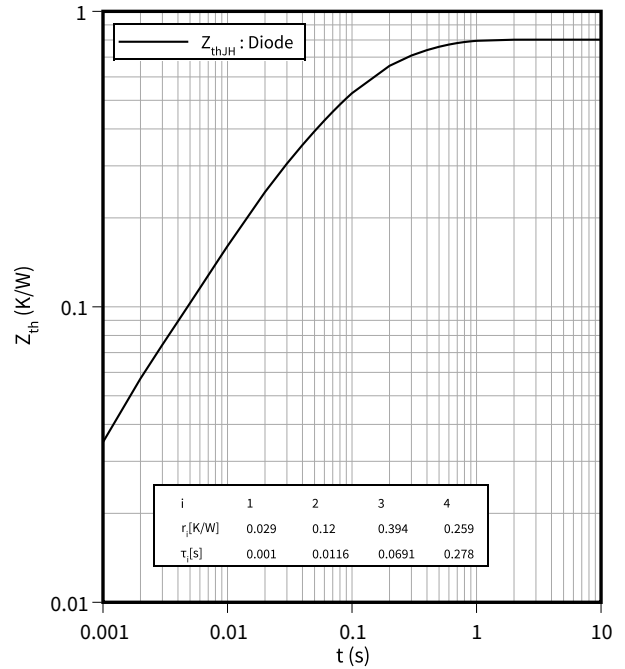
$E_{rec} = f(R_G)$

$I_F = 100\text{ A}, V_R = 400\text{ V}$



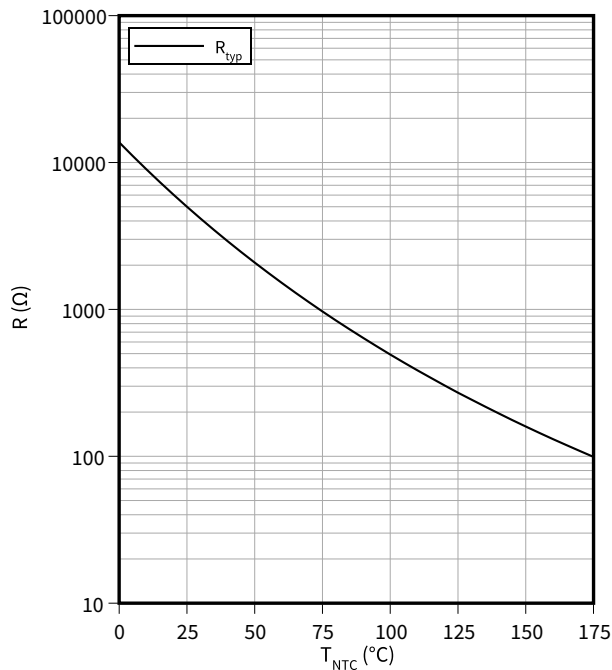
**Transient thermal impedance, Diode, 3-Level**

$Z_{th} = f(t)$



**Temperature characteristic (typical), NTC-Thermistor**

$R = f(T_{NTC})$



## 8 Circuit diagram

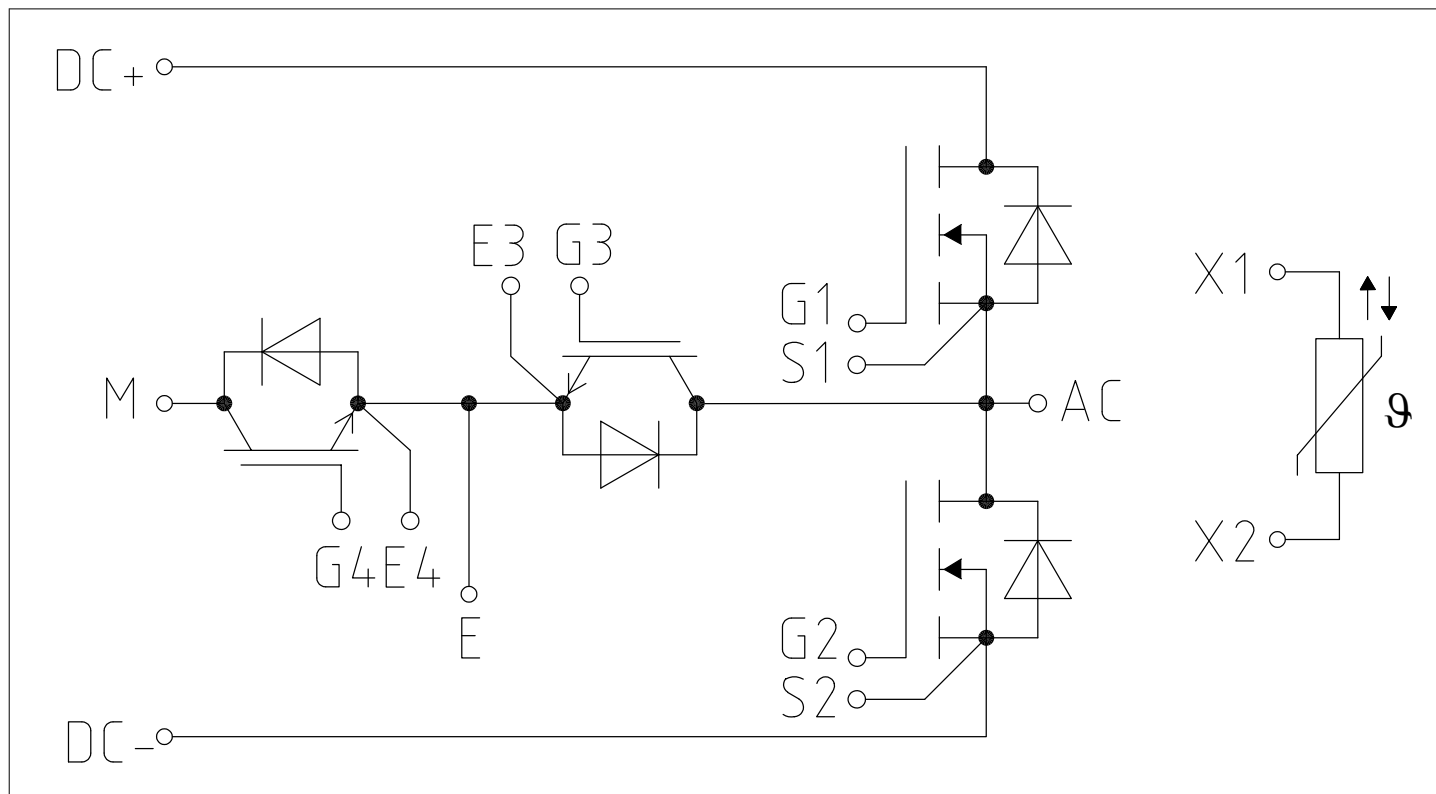


Figure 1

9 Package outlines

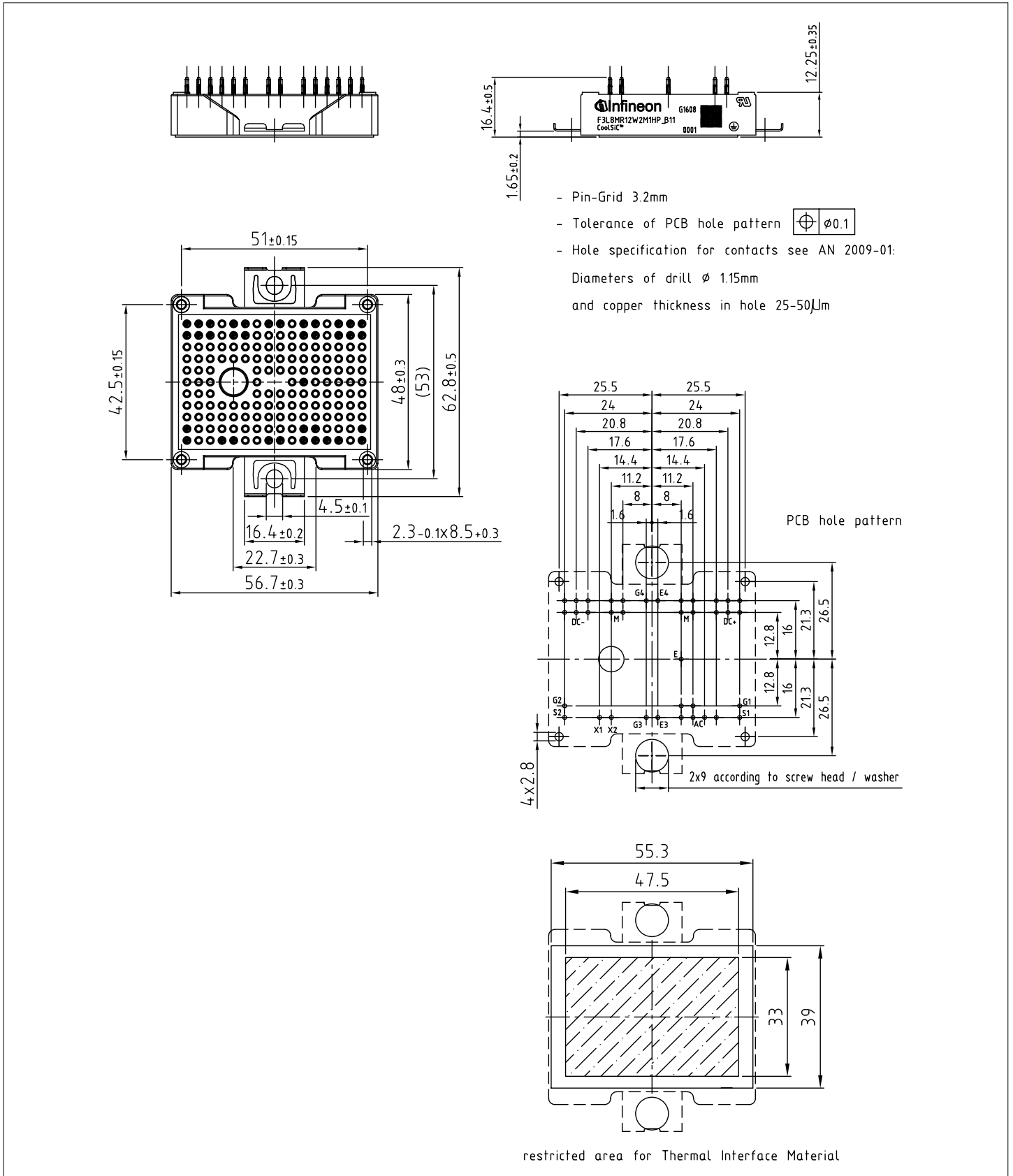

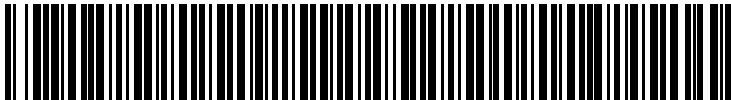


Figure 2

## 10 Module label code

| Module label code |  |                 |                         |
|-------------------|--|-----------------|-------------------------|
| Code format       | Data Matrix  | Barcode Code128 |                         |
| Encoding          | ASCII text   | Code Set A      |                         |
| Symbol size       | 16x16  | 23 digits       |                         |
| Standard          | IEC24720 and IEC16022  | IEC8859-1       |                         |
| Code content      | <i>Content</i>   | <i>Digit</i>    | <i>Example</i>          |
|                   | Module serial number   | 1 - 5           | 71549                   |
|                   | Module material number   | 6 - 11          | 142846                  |
|                   | Production order number  | 12 - 19         | 55054991                |
|                   | Date code (production year)  | 20 - 21         | 15                      |
|                   | Date code (production week)  | 22 - 23         | 30                      |
| Example           |   |                 |                         |
|                   | 71549142846550549911530  |                 | 71549142846550549911530 |

**Figure 3**

## Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10              | 2021-04-07      |                        |
| 1.00              | 2022-03-09      | Final datasheet        |
| 1.10              | 2022-03-10      | Final datasheet        |

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**Document reference**

**IFX-ABA497-003**

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